

CMK invites you

Booth: Hall South, S4-25

High-Reliability HDI

Prepreg build-up PCB (PPBU)

Variation of HDI (PPBU) structure

PPBU 1-2-1 PPBU 1-4-1 PPBU 2-4-2

Heat Dissipation Support

Our PWBs called CMK-COMP series can have performances for High-heat radiation and High-current.

CMK-COMP series

- Cu base**: Heat radiation directly to Cu board.
- Cu core**: Heat-spread to whole PWB.
- Inner circuit thick Cu**: High-current can be allowed with thick Cu.

One-stop solution

By providing consistent support from design onward, we reduce inter-process workload for our customers and deliver assembled PCBs directly to you.

PCB Specification Proposal Component Procurement

We can propose PCB specifications tailored to requirements such as high-speed transmission and thermal countermeasures.

Prototype Phase: Components can be procured through e-commerce sites for quick-turn delivery.
Mass Production Phase: Procurement from distributors offering stable supply and quality support is available.

Simulation technology

Heat Analysis

Exothermic performance and heat resistance will be improved by adjustment of pattern width and additional via



Please scan this 2D barcode to pre-register.

※As this is a pre-registration-only exhibition, please register to attend before visiting.

<https://www.spexa.jp/tokyo/en-gb/register.html?code=1647735744464059-ZDY>

We sincerely look forward to your visit.